

# 产品规格书

批 淮	审 核	校 核	编 制
纪春华	朴致均	赵宇辉	郑羿
2019.08.05	2019.08.05	2019.08.05	2019.08.05

## 规格书更改履历:

序号	更改内容	履历号	更改时间	责任人
1	新规制定	000	2019.08.05	郑羿

此规格如果需要申请样品 , 请联络  
0755-23073210  
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## SWITCHING REGULATOR APPLICATIONS

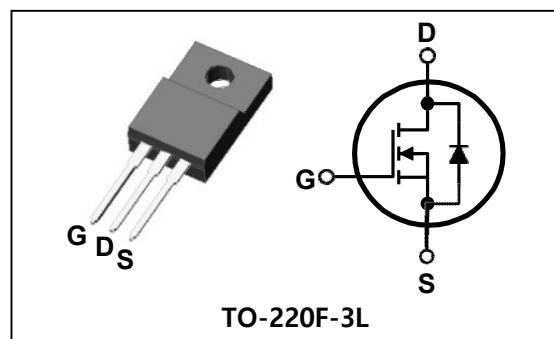
### Features

- High Voltage :  $BV_{DSS}=650V$ (Min.)
- Low  $C_{rss}$  :  $C_{rss}=14.5pF$ (Typ.)
- Low gate charge :  $Q_g=38nC$ (Typ.)
- Low  $R_{DS(on)}$  :  $R_{DS(on)}=0.88\Omega$ (Max.)

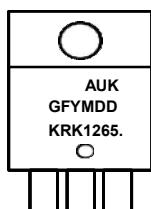
### Ordering Information

Type No.	Marking	Package Code
KRK1265F	KRK1265.	TO-220F-3L
KRK1265FA	KRK1265.	TO-220F-3L

### PIN Connection



### Marking Diagram



Column 1 : Manufacturer  
 Column 2 : Production Information  
 e.g.) GFYMDD  
 - . G : Option Code (H : Halogen Free)  
 - . F : Factory management code  
 - . YMDD : Date Code (year, month, date)  
 Column 3 : Device Code . Dalian

### Absolute maximum ratings ( $T_c=25^\circ C$ unless otherwise noted)

Characteristic	Symbol		Rating	Unit
Drain-source voltage	$V_{DSS}$		650	V
Gate-source voltage	$V_{GSS}$		$\pm 30$	V
Drain current (DC) *	$I_D$	$T_c=25^\circ C$	12	A
		$T_c=100^\circ C$	7.58	A
Drain current (Pulsed) *	$I_{DM}$		48	A
Power dissipation	$P_D$		32	W
Avalanche current (Single) ②	$I_{AS}$		12	A
Single pulsed avalanche energy ②	$E_{AS}$		140	mJ
Avalanche current (Repetitive) ①	$I_{AR}$		12	A
Repetitive avalanche energy ①	$E_{AR}$		3.2	mJ
Junction temperature	$T_J$		150	$^\circ C$
Storage temperature range	$T_{stg}$		-55~150	

\* Limited by maximum junction temperature

Characteristic	Symbol	Typ.	Max.	Unit
Thermal resistance	$R_{th(J-C)}$	-	3.9	$^\circ C/W$
	$R_{th(J-A)}$	-	62.5	

# KRK1265F/FA

## Electrical Characteristics ( $T_c=25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Drain-source breakdown voltage	$\text{BV}_{\text{DSS}}$	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	650	-	-	V
Gate threshold voltage	$V_{GS(\text{th})}$	$I_D=250\mu\text{A}, V_{DS}=V_{GS}$	2.0	-	5.0	V
Drain-source cut-off current	$I_{\text{DSS}}$	$V_{DS}=650\text{V}, V_{GS}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate leakage current	$I_{\text{GSS}}$	$V_{DS}=0\text{V}, V_{GS}=\pm30\text{V}$	-	-	$\pm100$	nA
Drain-source on-resistance <sup>(4)</sup>	$R_{\text{DS(on)}}$	$V_{GS}=10\text{V}, I_D=6.0\text{A}$	-	0.68	0.88	$\Omega$
Forward transfer conductance <sup>(4)</sup>	$g_{fs}$	$V_{DS}=10\text{V}, I_D=6.0\text{A}$	-	13.5	-	S
Input capacitance	$C_{iss}$	$V_{GS}=0\text{V}, V_{DS}=25\text{V}$ $f=1\text{ MHz}$	-	2470	-	pF
Output capacitance	$C_{oss}$		-	160	-	
Reverse transfer capacitance	$C_{rss}$		-	14.5	-	
Turn-on delay time	$t_{d(\text{on})}$	$V_{DD}=325\text{V}, I_D=12\text{A}$ $R_G=25\Omega$	-	38	-	ns
Rise time	$t_r$		-	95	-	
Turn-off delay time	$t_{d(\text{off})}$		-	155	-	
Fall time	$t_f$		-	105	-	
Total gate charge	$Q_g$	$V_{DS}=520\text{V}, V_{GS}=10\text{V}$ $I_D=12\text{A}$	-	38	45	nC
Gate-source charge	$Q_{gs}$		-	15	-	
Gate-drain charge	$Q_{gd}$		-	9	-	

## Source-Drain Diode Ratings and Characteristics ( $T_c=25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Source current (DC)	$I_s$	Integral reverse diode in the MOSFET	-	-	12	A
Source current (Pulsed) <sup>(1)</sup>	$I_{sM}$		-	-	48	
Forward voltage <sup>(4)</sup>	$V_{SD}$	$V_{GS}=0\text{V}, I_s=12\text{A}$	-	-	1.4	V
Reverse recovery time	$t_{rr}$	$I_s=12\text{A}, V_{GS}=0\text{V}$ $dI_F/dt=100\text{A}/\mu\text{s}$	-	500	-	ns
Reverse recovery charge	$Q_{rr}$		-	4.3	-	uC

Note :

① Repetitive rating : Pulse width limited by maximum junction temperature

②  $L=1.8\text{mH}, I_{AS}=12\text{A}, V_{DD}=50\text{V}, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$

③ Pulse Test : Pulse width  $\leq 300\text{us}$ , Duty cycle  $\leq 2\%$

④ Essentially independent of operating temperature

## Electrical Characteristic Curves

Fig. 1 Typical Output Characteristics

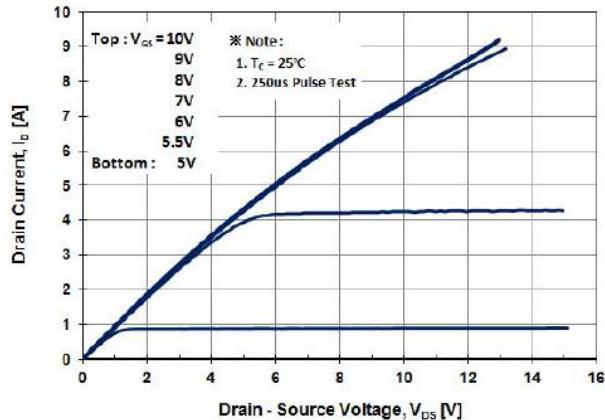


Fig. 2 Typical Output Characteristics

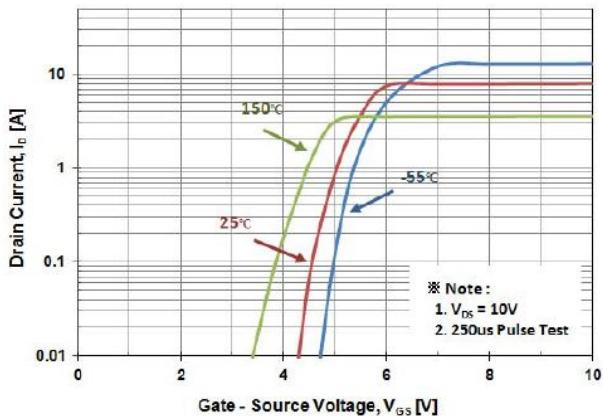


Fig. 3 On-Resistance Variation with Drain Current and Gate Voltage

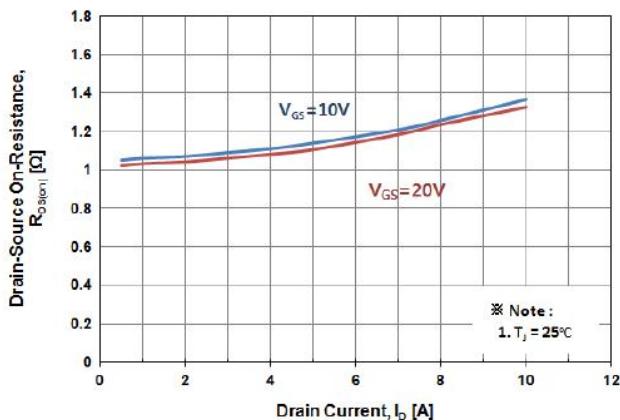


Fig. 4 Body Diode Forward Voltage Variation with Source Current

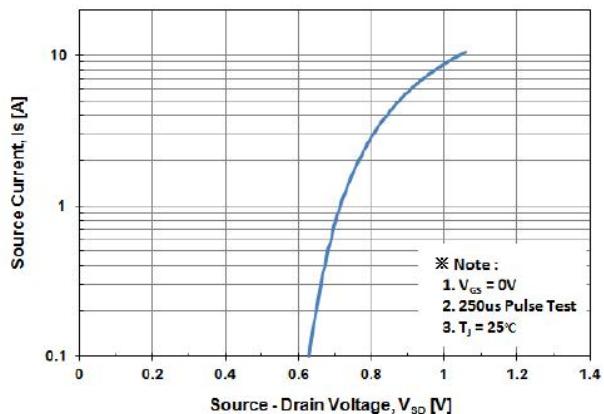


Fig. 5 Typical Capacitance Characteristics

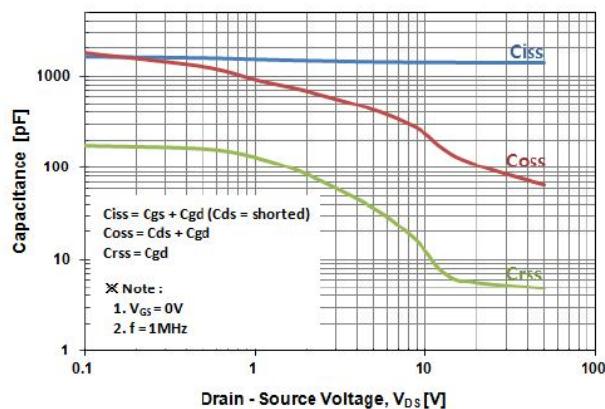
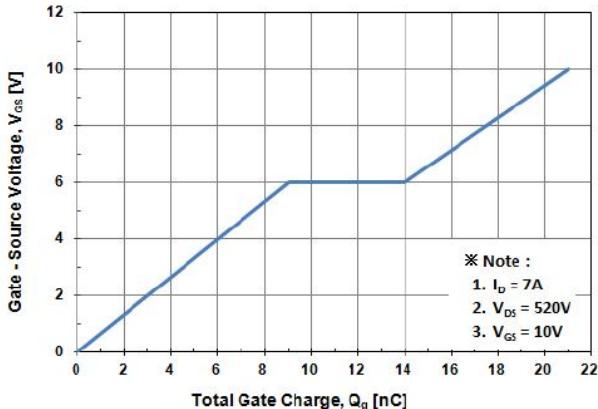


Fig. 6 Typical Total Gate Charge Characteristics



## Electrical Characteristic Curves

Fig. 7 Breakdown Voltage Variation vs. Temperature

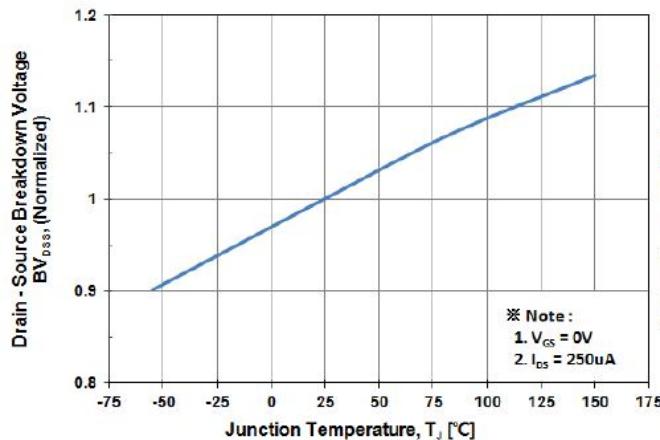


Fig. 8 On-Resistance Variation vs. Temperature

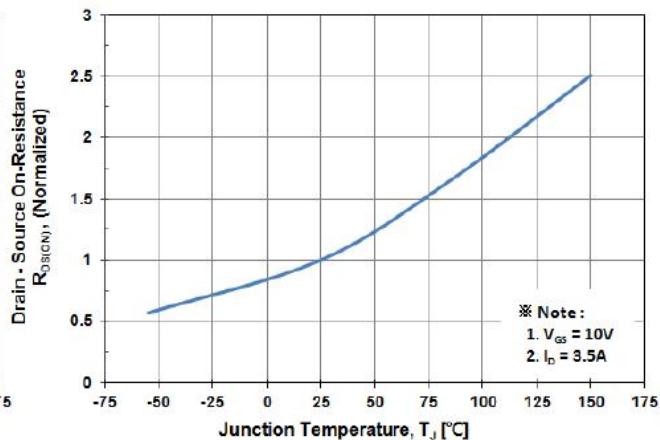


Fig. 9 Maximum Drain Current vs. Case Temperature

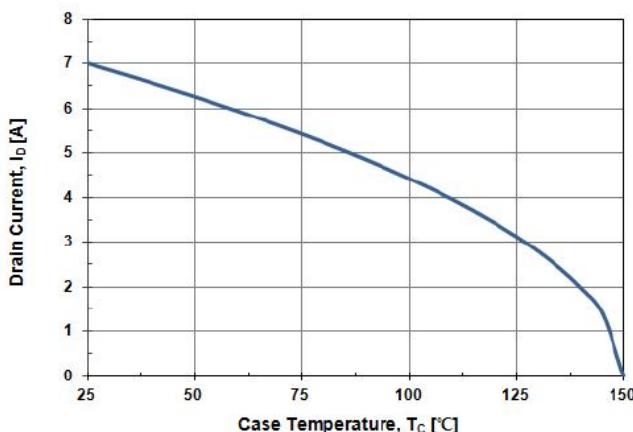


Fig. 10 Maximum Safe Operating Area

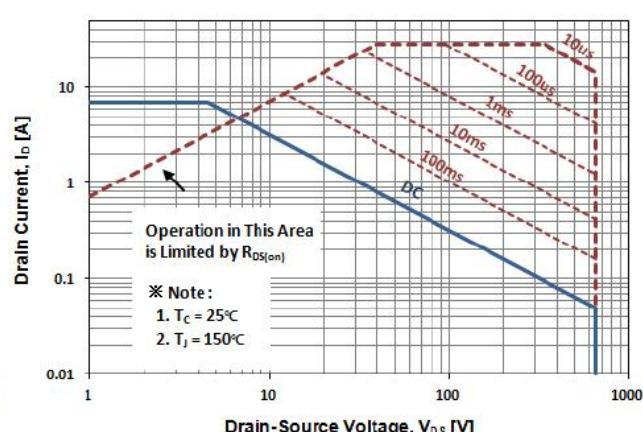


Fig. 11 Transient Thermal Impedance

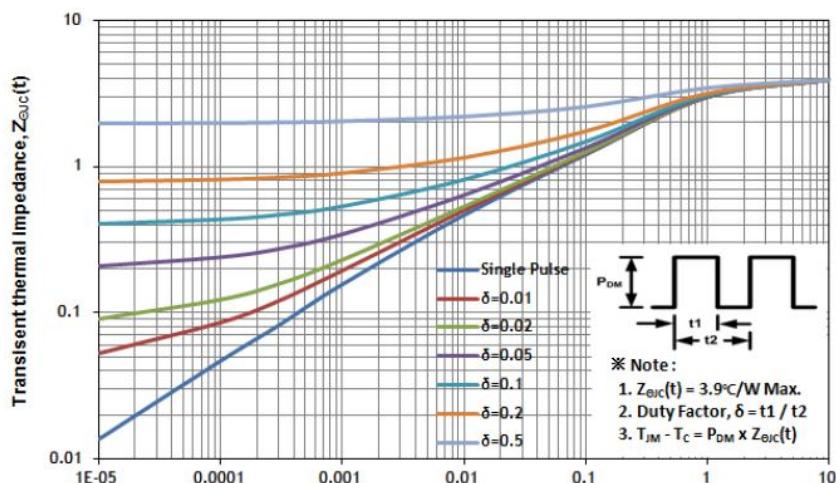


Fig. 12 Gate Charge Test Circuit & Waveform

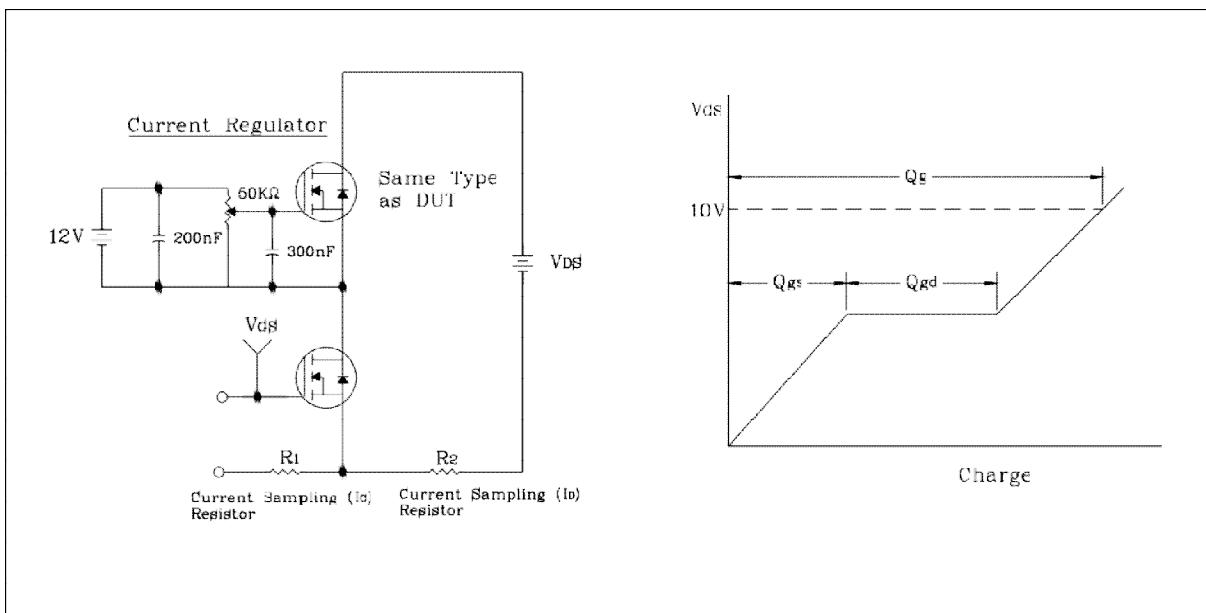


Fig. 13 Resistive Switching Test Circuit & Waveform

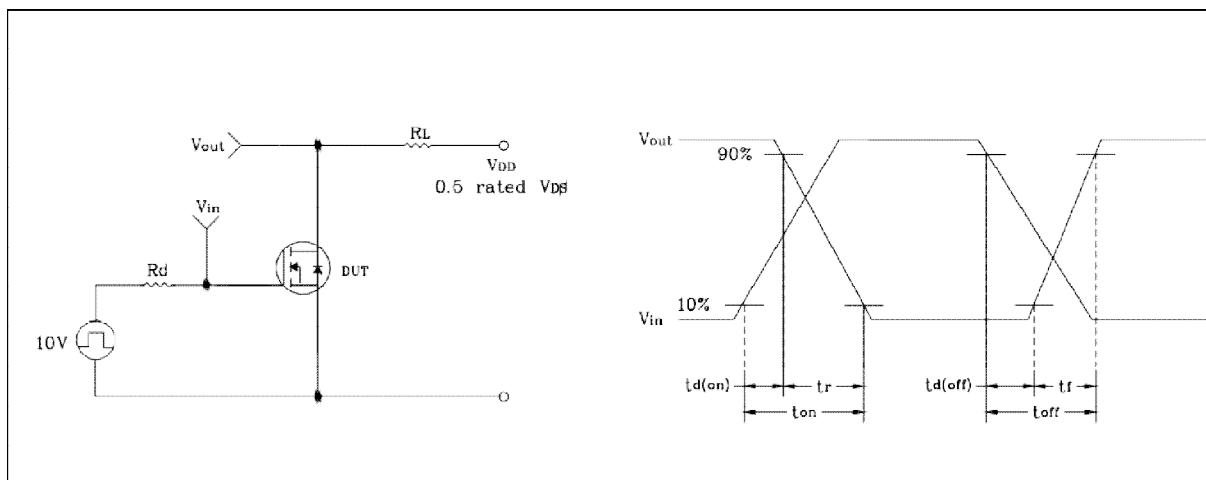


Fig. 14 EAS Test Circuit & Waveform

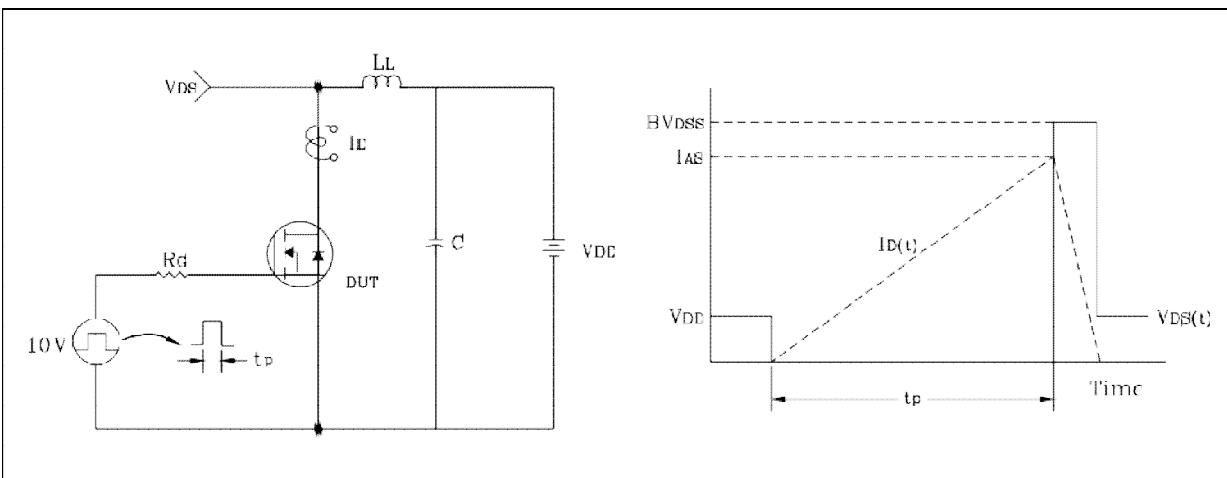
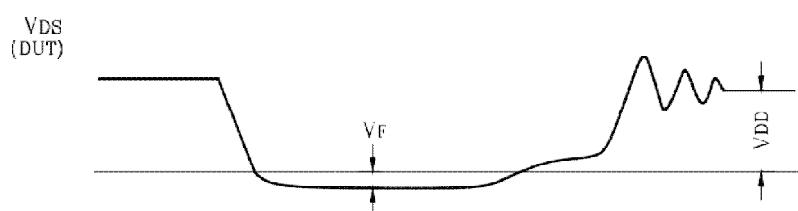
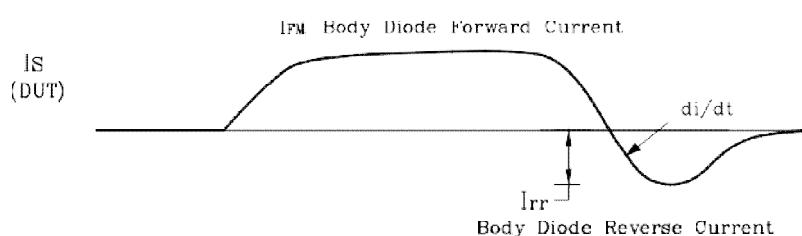
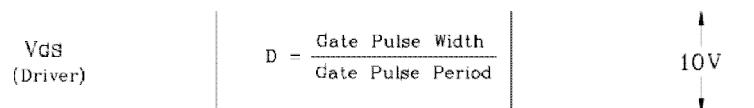
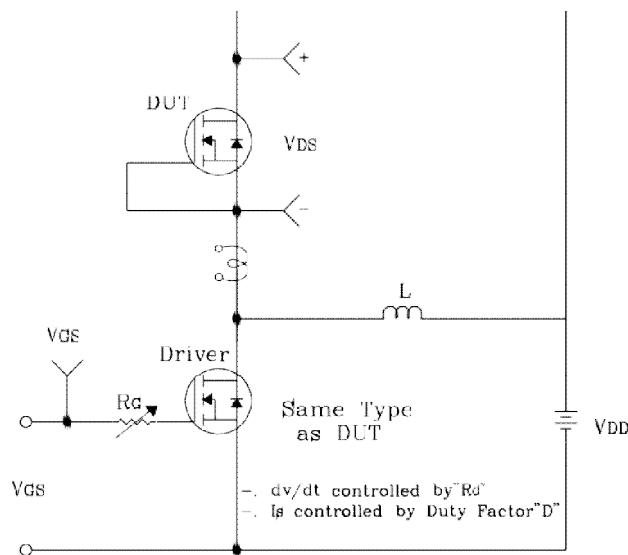
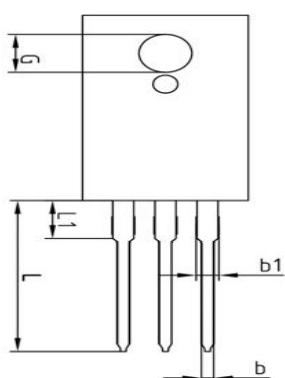
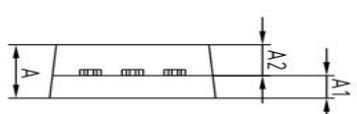
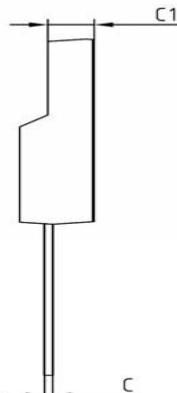
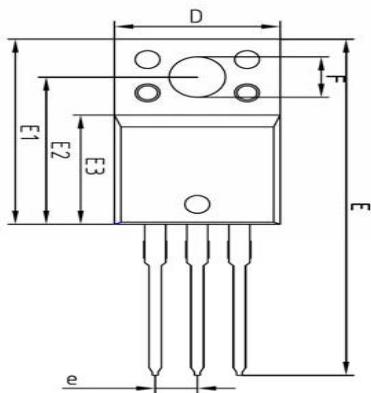


Fig. 15 Diode Reverse Recovery Time Test Circuit & Waveform

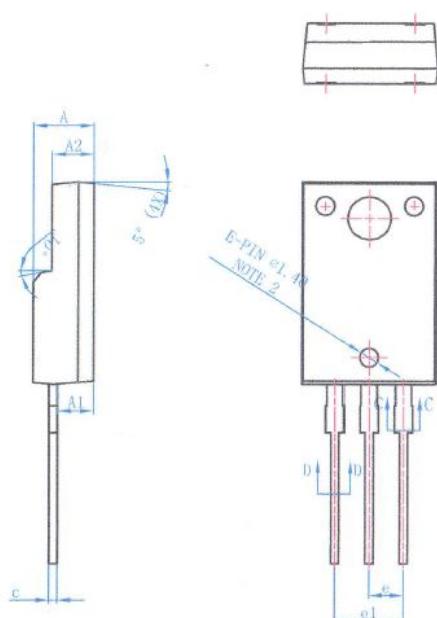
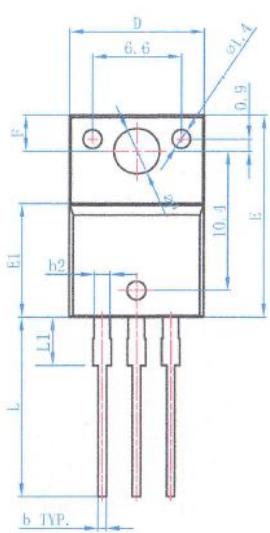


## Outline Dimension

unit: mm

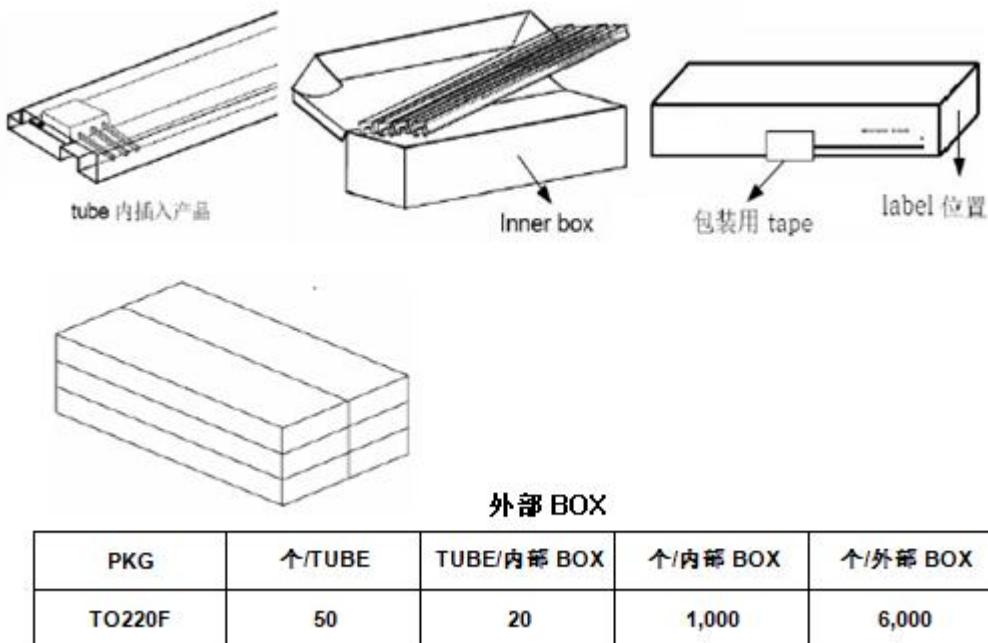


SYMBOL	MILLIMETERS			NOTE
	MINIMUM	NOMINAL	MAXIMUM	
A	—	—	4.60	
A <sub>1</sub>	2.45	2.50	2.55	
A <sub>2</sub>	1.95	2.00	2.05	
b	0.65	0.75	0.85	
b <sub>1</sub>	1.07	1.27	1.47	
C	0.40	0.50	0.60	
C <sub>1</sub>	2.70	2.80	2.90	
D	9.90	10.00	10.10	
E	28.00	—	28.60	
E <sub>1</sub>	15.50	15.60	15.70	
E <sub>2</sub>	12.30	12.40	12.50	
E <sub>3</sub>	9.15	9.20	9.25	
F	3.30	3.40	3.50	
G	3.10	3.20	3.30	
e	—	2.54 BSC	—	
L	12.40	—	13.00	
L <sub>1</sub>	3.46	BSC	—	



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	4.20	4.50	4.80	0.165	0.177	0.189
A <sub>1</sub>	2.50	—	2.90	0.098	—	0.114
A <sub>2</sub>	2.90	3.10	3.30	0.114	0.122	0.130
b	0.30	0.60	0.90	0.012	0.024	0.035
b <sub>1</sub>	0.30	—	0.90	0.012	—	0.035
b <sub>2</sub>	1.00	1.20	1.40	0.039	0.047	0.055
b <sub>3</sub>	1.00	—	1.40	0.039	—	0.055
c	—	0.60	—	—	0.024	—
D	9.90	10.00	10.10	0.390	0.394	0.398
E	14.80	15.10	15.40	0.583	0.594	0.606
E <sub>1</sub>	8.40	8.50	8.60	0.331	0.335	0.339
e	—	2.55BSC	—	—	0.100BSC	—
e <sub>1</sub>	—	5.10BSC	—	—	0.200BSC	—
F	2.55	2.70	2.85	—	0.106	0.112
L	13.00	13.40	13.80	0.512	0.528	0.543
L <sub>1</sub>	3.45	3.60	3.75	0.136	0.142	0.148
eP	2.90	3.20	3.50	0.114	0.126	0.138

## Packing Spec



**The AUK Dalian Corp. products are intended for the use as components in general electronic equipment (Office and communication equipment, measuring equipment, home appliance, etc.).**

**Please make sure that you consult with us before you use these AUK Dalian Corp. products in equipments which require high quality and / or reliability, and in equipments which could have major impact to the welfare of human life(atomic energy control, airplane, spaceship, transportation, combustion control, all types of safety device, etc.). AUK Dalian Corp. cannot accept liability to any damage which may occur in case these AUK Dalian Corp. products were used in the mentioned equipments without prior consultation with AUK Dalian Corp..**

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